

Approval Sheet

(產品承認書)

產品名稱 (Product): BT 4.2 & BT 5 Module (nRF52832)

using **WLCSP** Package IC

產品型號 (Model No.): **MDBT42 – 512KV2** (Chip Antenna)

MDBT42 – P512KV2 (PCB Antenna)

Advantage of MDBT42 & MDBT42-P series:

1. *Long working distance:*

MDBT42: *over 80 meters in open space.*

MDBT42-P: *up to 60 meters in open space.*

2. *Declaration ID includes all Nordic applied profiles.*

3. *Granted main regional certification such as FCC (USA), CE (EU) TELECOM (Japan), SRRC (China), IC (Canada), NCC (Taiwan), and KC (South Korea).*

Index

1. Overall Introduction	4
1.1. Application	4
1.2. Features	5
1.3. Profile & Service Information	6
2. Product Dimension	7
2.1. PCB Dimensions & Pin Indication	7
2.2. Recommended Layout of Solder Pad	9
2.3. RF Layout Suggestion (aka Keep-Out Area)	13
2.4. Footprint & Design Guide	15
2.5. Pin Assignment	16
2.6. GPIO Located Near the Radio	18
3. Main Chip Solution	18
4. Shipment Packaging Information	19
4.1. Marking on Metal Shielding	20
5. Specification	21
5.1. Absolute Maximum Ratings	21
5.2. Operation Conditions	21
5.3. Electrical Specifications	22
6. Block Diagram	27
7. Antenna	28
7.1. MDBT42	28
7.2. MDBT42-P	29
8. Reference Circuit	30
9. Certification	31
9.1. Declaration ID	31
9.2. FCC Certificate (USA)	33
9.3. TELEC Certificate (Japan)	34
9.4. NCC Certificate (Taiwan)	35
9.5. CE Test Report (EU)	37
9.6. IC Certificate (Canada)	38
9.7. SRRC Certificate (China)	39
9.8. KC Certificate (South Korea)	40
9.9. RoHS & REACH Report	41
9.10. End-Product Label	42

10. Notes and Cautions..... 44

11. Basic Facts for nRF52 Chip..... 45

12. Useful Links 46

Full List of Raytac’s BLE Modules 47

Release Note 49



1. Overall Introduction

Raytac's MDBT42 & MDBT42-P is a BT 4.0, BT 4.1, BT 4.2 and BT 5 stack (Bluetooth low energy or BLE) module designed based on **Nordic nRF52832 SoC solution**, which incorporates: **GPIO, SPI, UART, I2C, I2S, PWM, ADC** and **NFC** interfaces for connecting peripherals and sensors.

Features of the module:

1. Dual Transmission mode of BLE & 2.4Ghz RF upon customer preference.
2. Compact size with **(L) 13.8 x (W) 8.8 x (H) 1.9 mm**.
3. Low power requirements, ultra-low peak, average and idle mode power consumption.
4. Be compatible with a large installed base of mobile phones, tablets and computers.
5. Fully coverage of BLE software stack. Click to see [1.3 Profile & Service Information](#).
6. BLE & RF transmission switching helps products fit all operation system and most hardware.

1.1. Application

- IoT
 - Home automation
 - Sensor networks
 - Building automation
- Personal Area Networks
 - Health / fitness sensor and monitor device
 - Medical devices
 - Key-fobs and wrist watches
- Interactive entertainment devices
 - Remote control
 - Gaming controller
- Beacons
- A4WP wireless chargers and devices
- Remote control toys
- Computer peripherals and I/O devices
 - Mouse
 - Keyboard
 - Multi-touch trackpad

1.2. Features

- Multi-protocol 2.4GHz radio
- 32-bit ARM Cortex – M4F processor
- 512KB flash programmed memory and 64KB RAM
- Software stacks available as downloads
- Application development independent from protocol stack
- On-air compatible with nRF51, nRF24AP and nRF24L series
- Programmable output power from +4dBm to -20dBm
- RSSI
- RAM mapped FIFOs using EasyDMA
- Dynamic on-air payload length up to 256 bytes
- Flexible and configurable 32 pin GPIO
- Programmable peripheral interface - PPI
- Simple ON / OFF global power mode
- Full set of digital interface all with Easy DMA including:
 - 3 x Hardware SPI master ; 3 x Hardware SPI slave
 - 2 x two-wire master ; 2 x two-wire slave
 - 1 x UART (CTS / RTS)
 - PDM for digital microphone
 - I2S for audio
- Quadrature demodulator
- 12-bit / 200KSPS ADC
- 128-bit AES ECB / CCM / AAR co-processor
- Low cost external crystal 32MHz \pm 40ppm for Bluetooth ; \pm 50ppm for ANT Plus
- Low power 32MHz crystal and RC oscillators
- Wide supply voltage range 1.7V to 3.6V
- On-chip DC/DC buck converter
- Individual power management for all peripherals
- Timer counter
 - 5 x 32-bit
 - 3 x 24-bit RTC
- Type 2 near field communication (NFC-A) tag with wakeup-on-field and touch-to-pair capabilities
- 3x 4-channel pulse width modulator (PWM) units with EasyDMA

1.3. Profile & Service Information

Profile & Service are supported by MDBT42 & MDBT42-P as below:

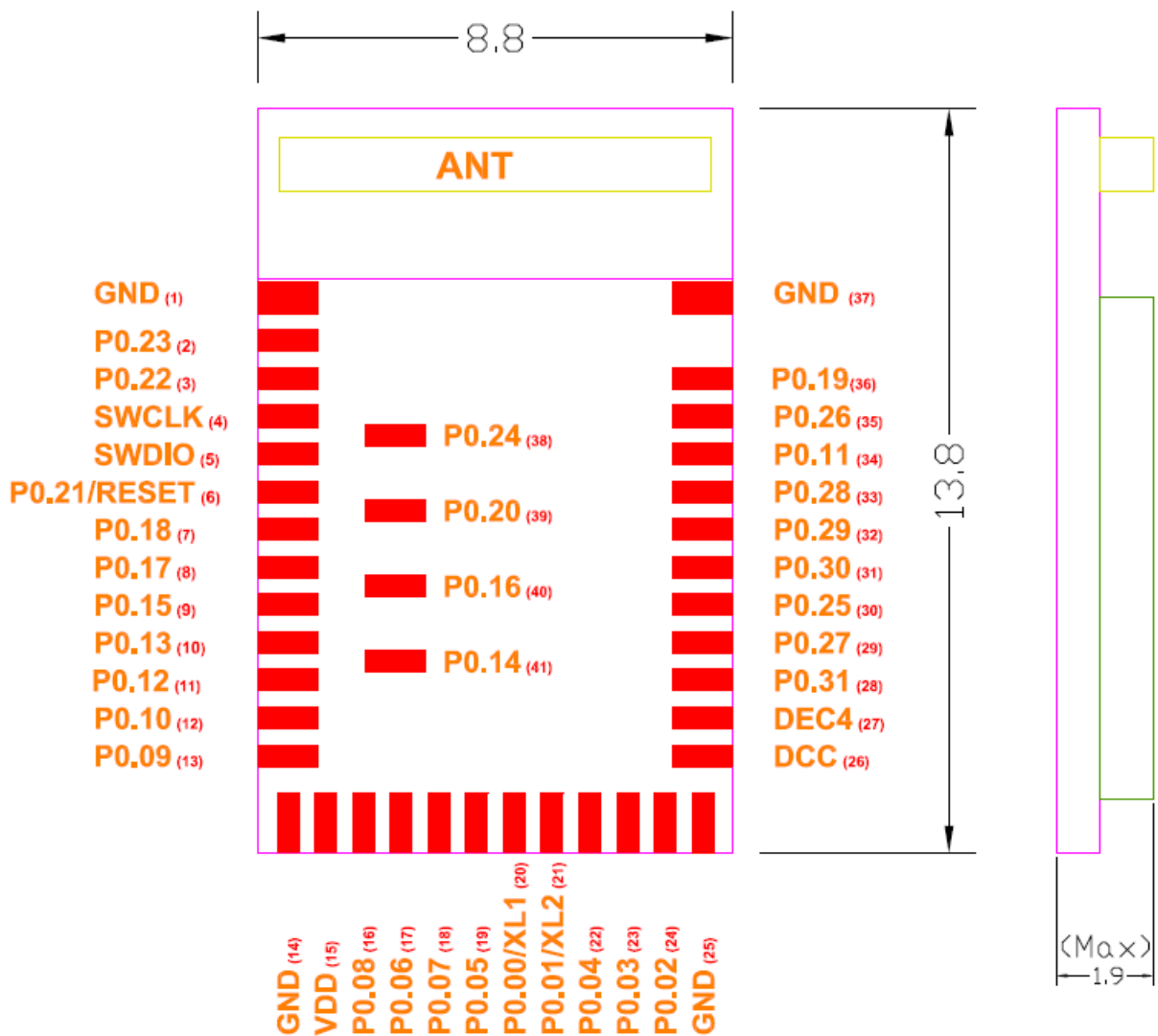
Profile Description	Service Description
Alert Notification Profile	Alert Notification Service
Blood Pressure Profile	Blood Pressure Service
	Device Information Service
Cycling Speed & Cadence Profile	Cycling Speed & Cadence Service
	Device Information Service
Glucose Profile	Glucose Service
	Device Information Service
Health Thermometer Profile	Health Thermometer Service
	Device Information Service
Heart Rate Profile	Heart Rate Service
	Device Information Service
HID over GATT Profile	HID Service
	Battery Service
Proximity Profile	Link Loss Service
	Immediate Alert Service
	TX Power Service
Running Speed & Cadence Profile	Running Speed & Cadence Service
	Device Information Service
Time Profile	Time Profile Service
Glucose Profile (Central)	

2. Product Dimension

2.1. PCB Dimensions & Pin Indication

- **MDBT42**

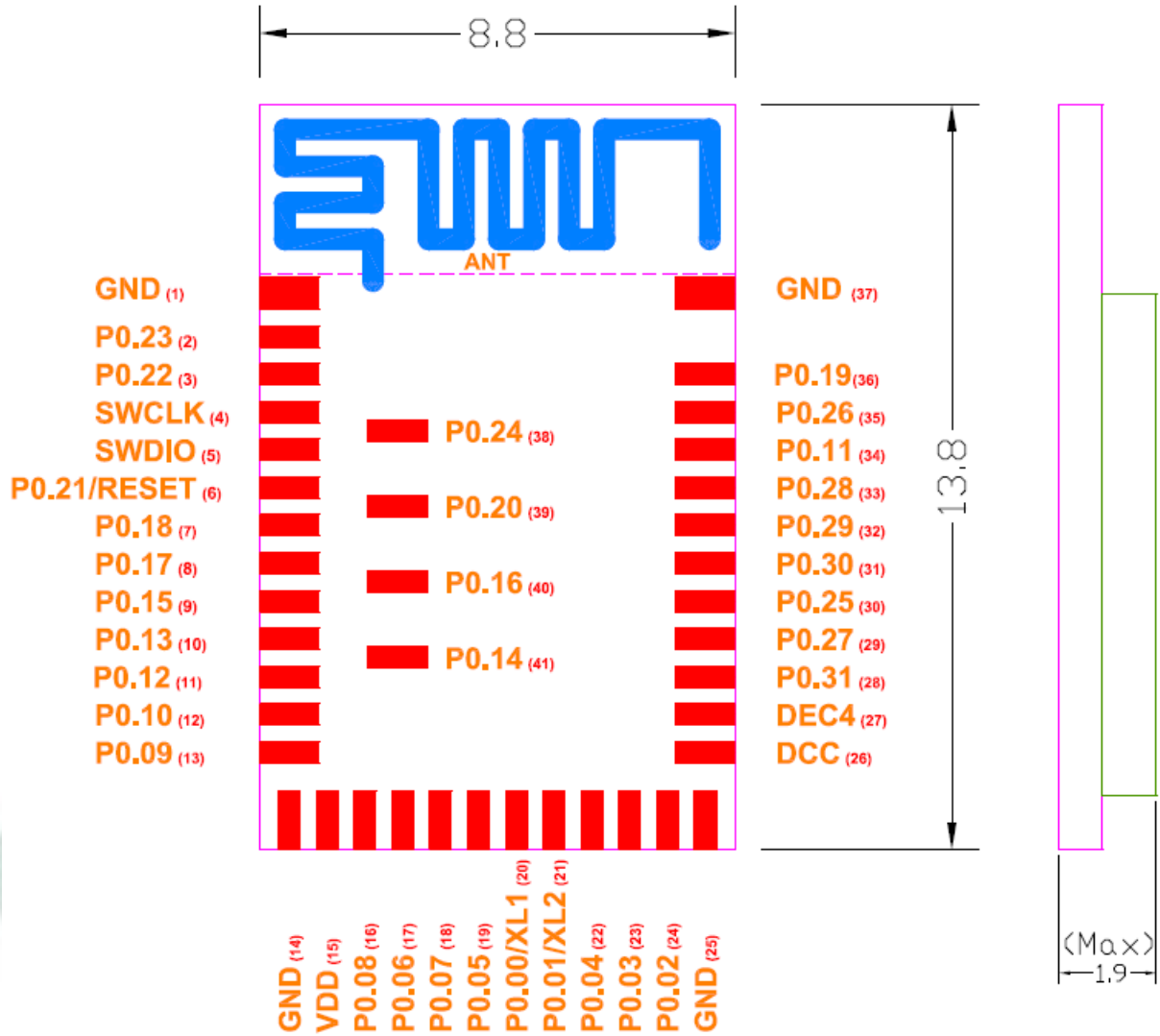
PCB SIZE: (L) 13.8 x (W) 8.8 x (H) 1.9 mm



TOP 單位:(mm)

• **MDBT42-P**

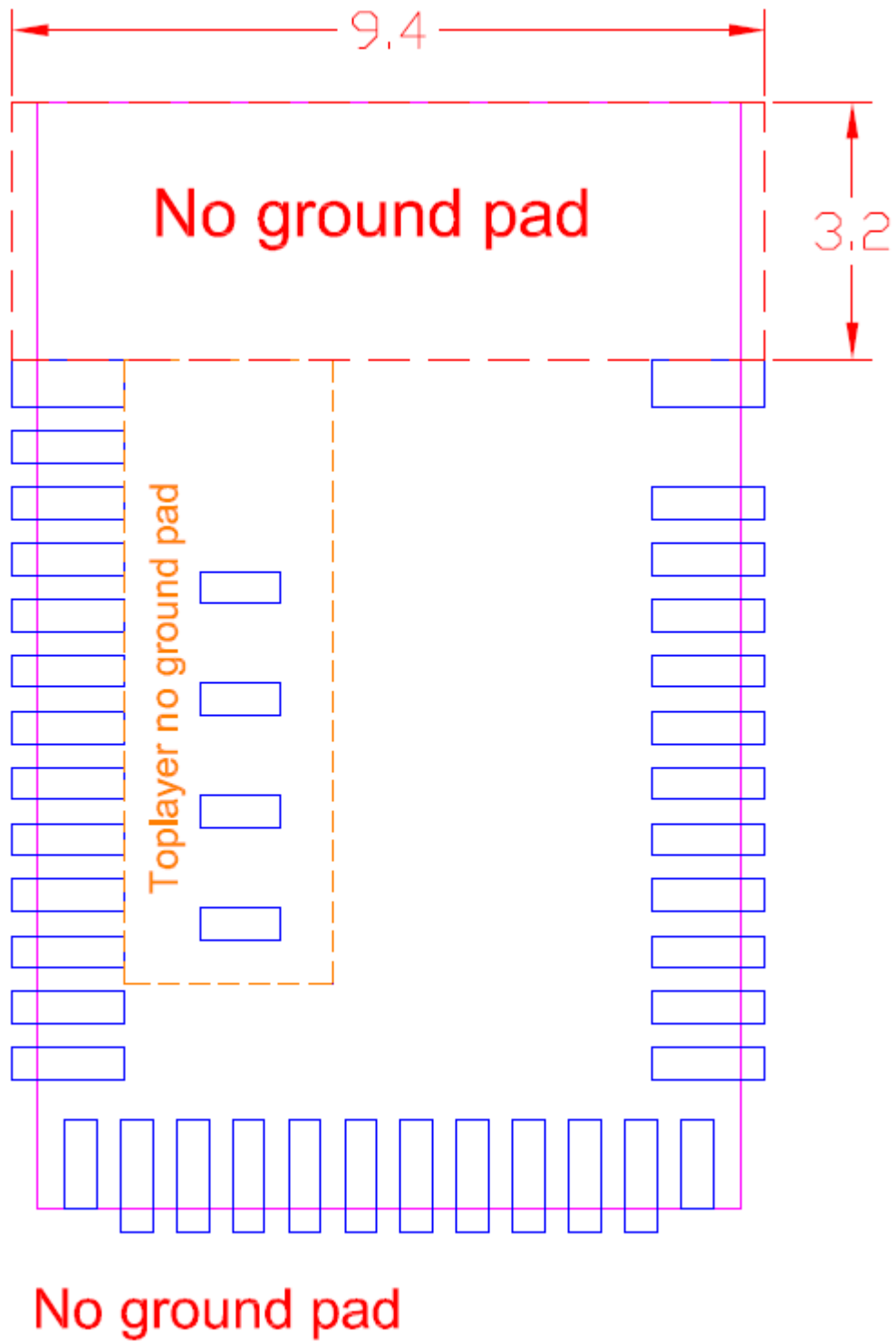
PCB SIZE: (L) 13.8 x (W) 8.8 x (H) 1.9 mm

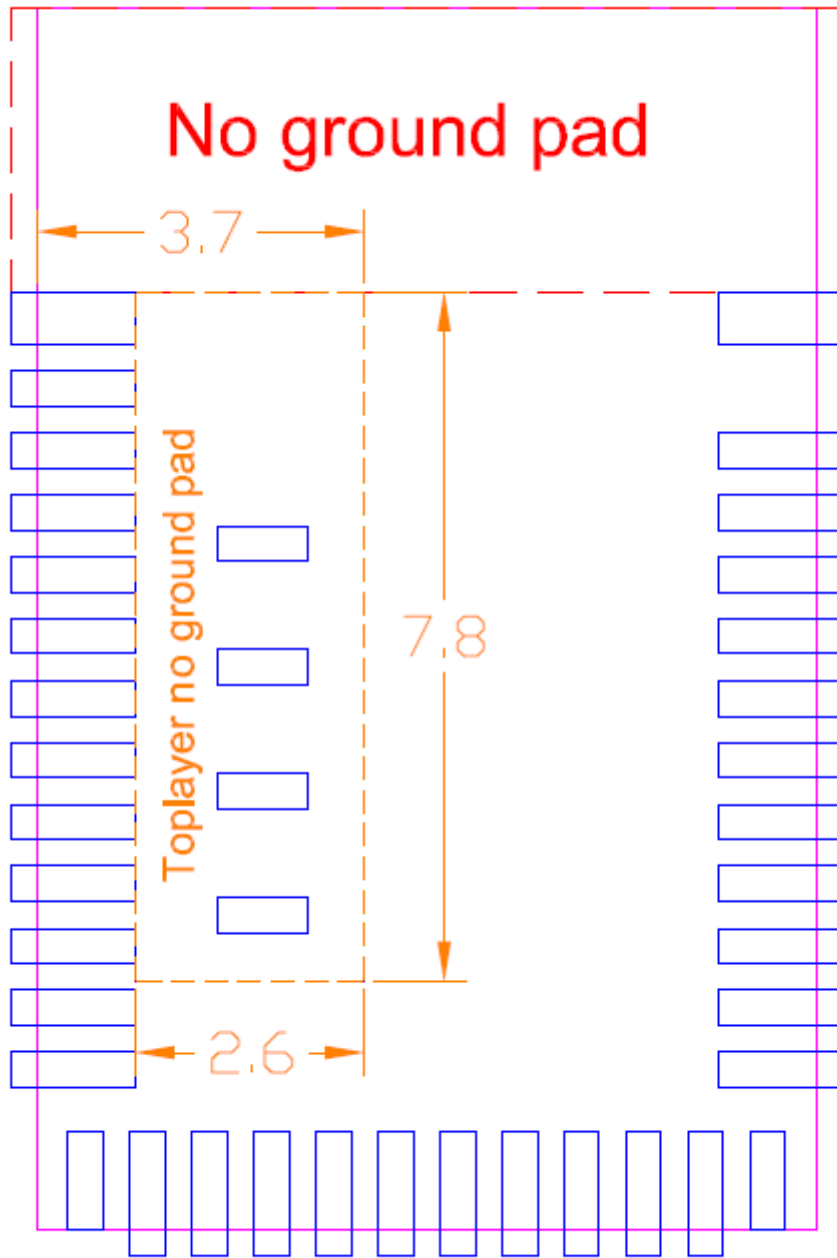


TOP 單位:(mm)

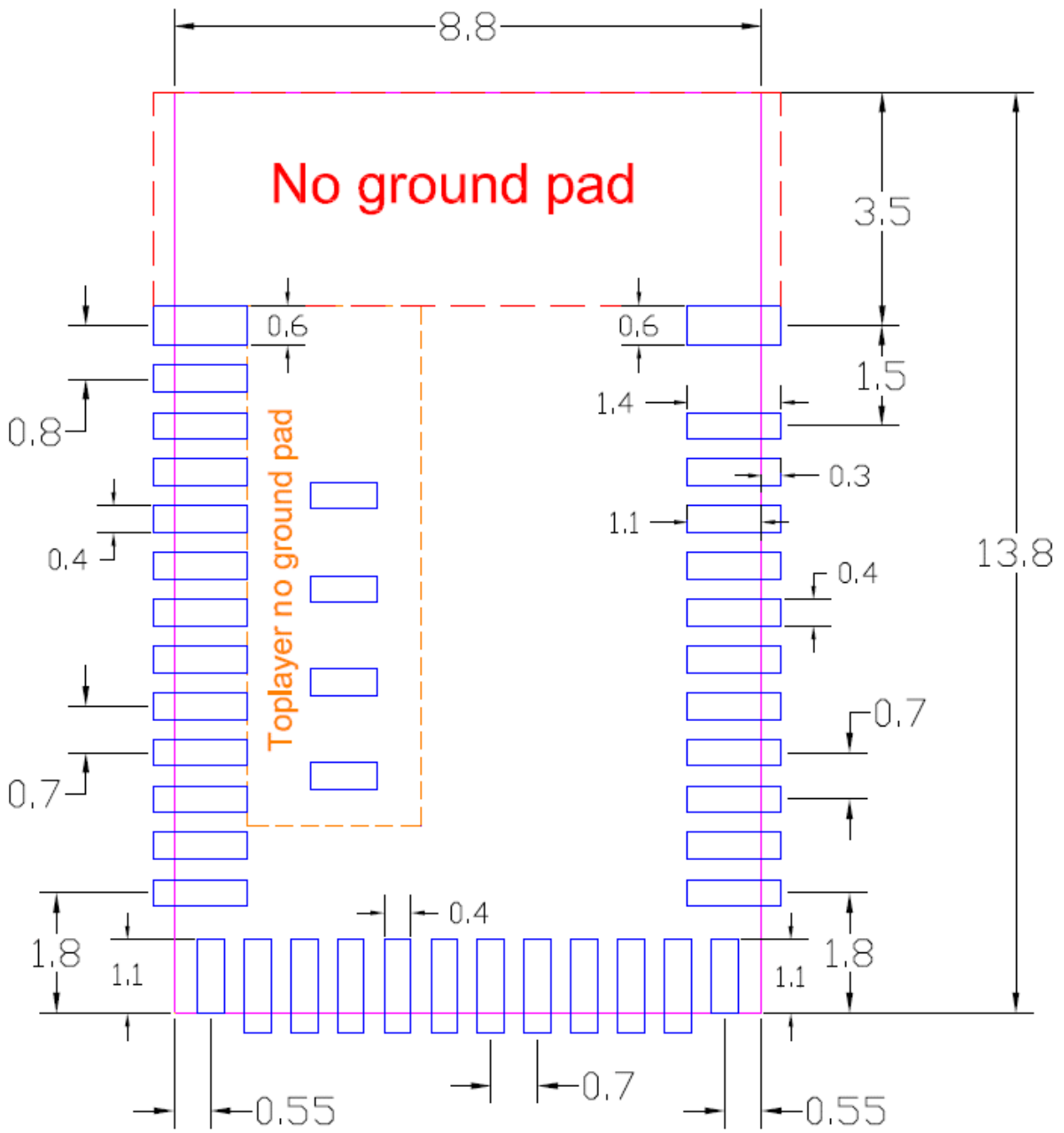
2.2. Recommended Layout of Solder Pad

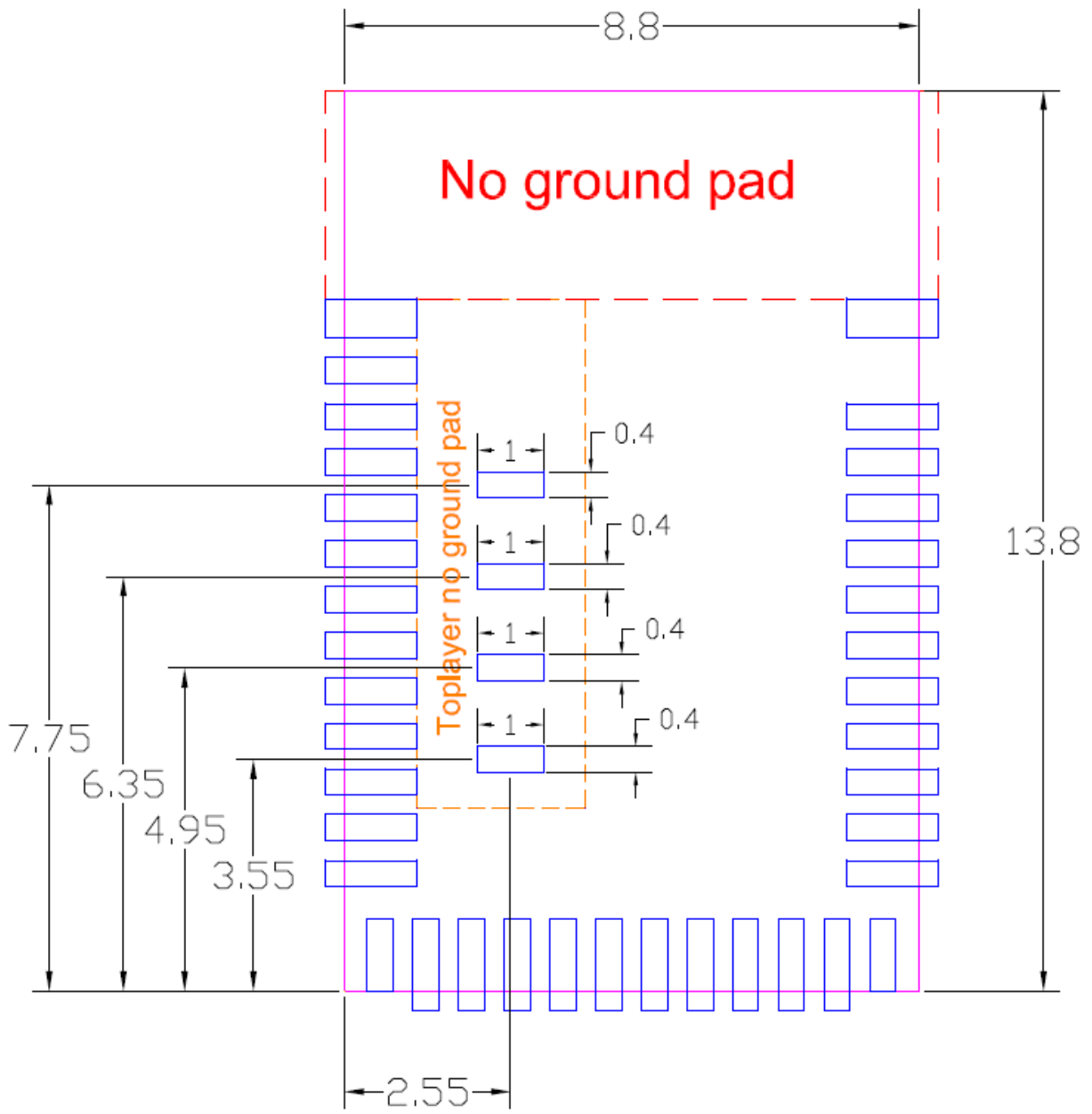
Graphs are all in Top View, Unit in mm.





Toplayer no ground pad

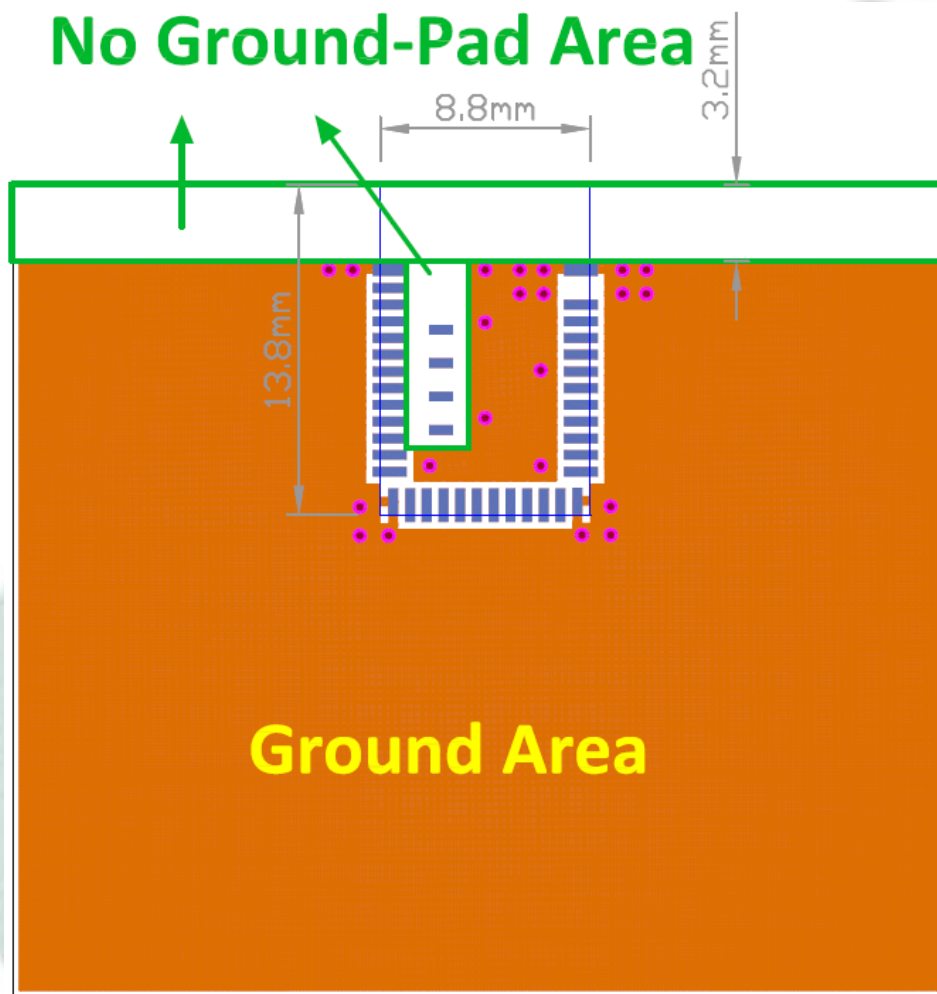




2.3. RF Layout Suggestion (aka Keep-Out Area)

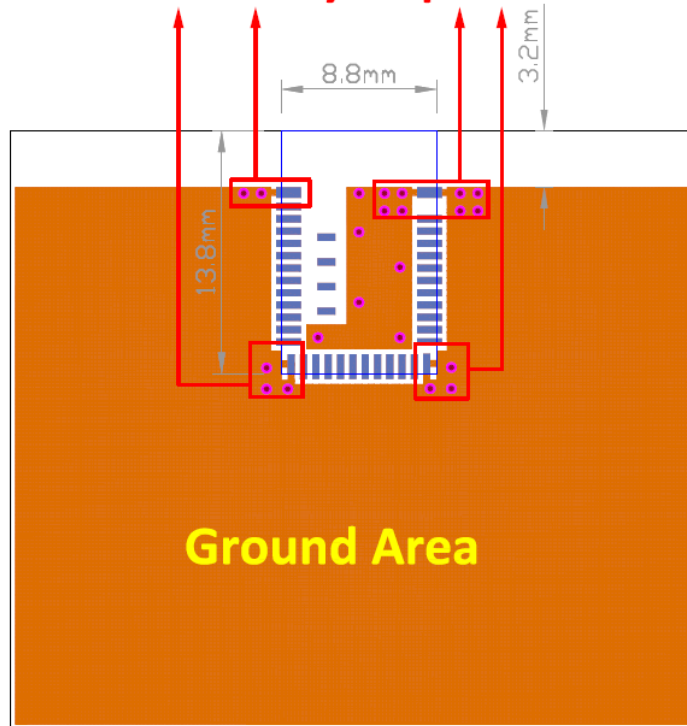
Please follow below instruction to have better wireless performance. Make sure to keep the “No-Ground-Pad” as wider as you can when there is no enough space in your design.

Welcome to send us your layout in PDF for review at service@raytac.com with title “Layout reviewing – MDBT42/MDBT42-P – YOUR company’s name”.

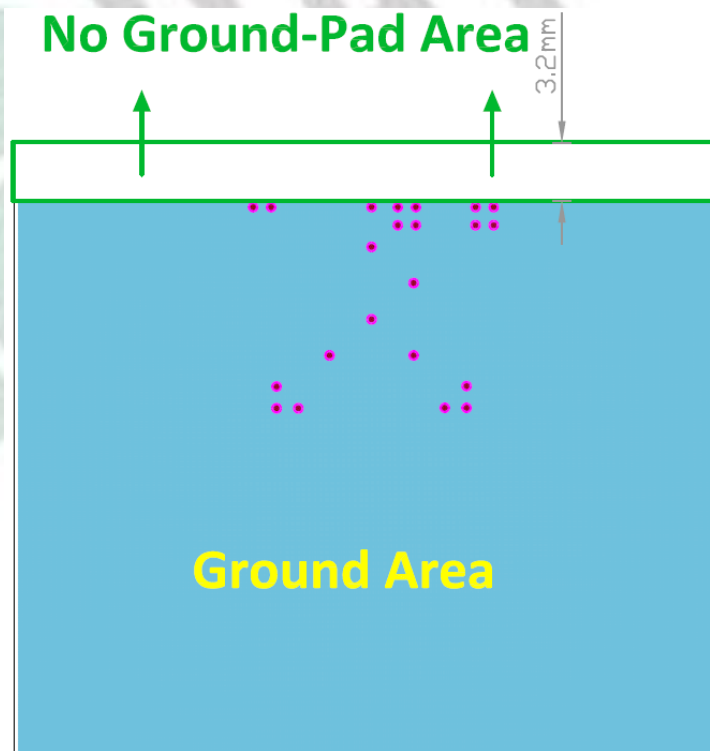


Top layer

Please add via holes in these areas as many as possible

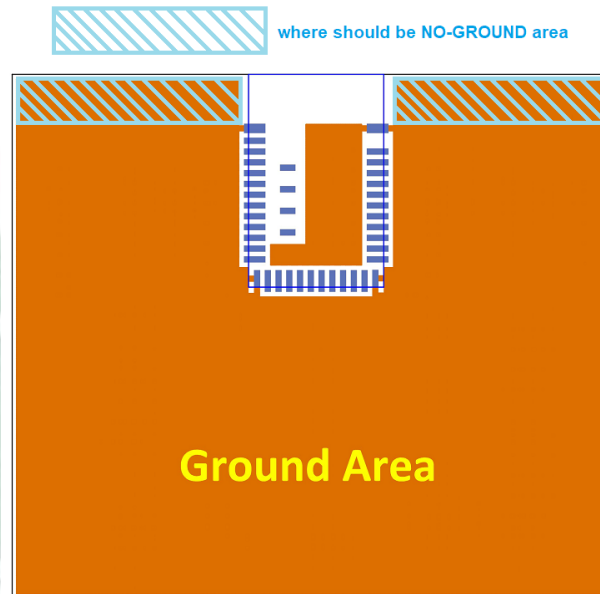
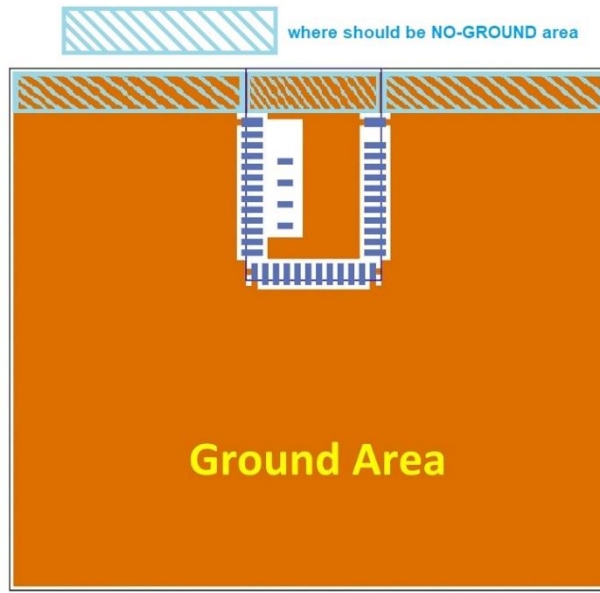


Top layer



Bottom layer

Examples of “**NOT RECOMMENDED**” layout



2.4. Footprint & Design Guide

[Click to download from our official website.](#)

2.5. Pin Assignment

Pin No.	Name	Pin function	Description
(1)	GND	Ground	The pad must be connected to a solid ground plane
(2)	P0.23	Digital I/O	General-purpose digital I/O
(3)	P0.22	Digital I/O	General-purpose digital I/O
(4)	SWDCLK	Digital input	Serial Wire debug clock input for debug and programming
(5)	SWDIO	Digital I/O	Serial Wire debug I/O for debug and programming
(6)	P0.21	Digital I/O	General-purpose digital I/O
	RESET		Configurable as system RESET pin
(7)	P0.18	Digital I/O	General-purpose digital I/O
	TraceData(0)		Trace port output
(8)	P0.17	Digital I/O	General-purpose digital I/O
(9)	P0.15	Digital I/O	General-purpose digital I/O
	TraceData(2)		Trace port output
(10)	P0.13	Digital I/O	General-purpose digital I/O
(11)	P0.12	Digital I/O	General-purpose digital I/O
(12)	P0.10	Digital I/O	General-purpose digital I/O
	NFC2	NFC input	NFC antenna connection
(13)	P0.09	Digital I/O	General-purpose digital I/O
	NFC1	NFC input	NFC antenna connection
(14)	GND	Ground	The pad must be connected to a solid ground plane
(15)	VDD	Power	Power-supply pin
(16)	P0.08	Digital I/O	General-purpose digital I/O
(17)	P0.06	Digital I/O	General-purpose digital I/O
(18)	P0.07	Digital I/O	General-purpose digital I/O
(19)	P0.05	Digital I/O	General-purpose digital I/O
	AIN3	Analog input	SAADC/COMP/LPCOMP input
(20)	P0.00	Digital I/O	General-purpose digital I/O
	XL1	Analog input	Connection to 32.768khz crystal (LFXO)
(21)	P0.01	Digital I/O	General-purpose digital I/O
	XL2	Analog input	Connection to 32.768khz crystal (LFXO)
(22)	P0.04	Digital I/O	General-purpose digital I/O
	AIN2	Analog input	SAADC/COMP/LPCOMP input
(23)	P0.03	Digital I/O	General-purpose digital I/O
	AIN1	Analog input	SAADC/COMP/LPCOMP input

Pin No.	Name	Pin function	Description
(24)	P0.02	Digital I/O	General-purpose digital I/O
	AIN0	Analog input	SAADC/COMP/LPCOMP input
(25)	GND	Ground	The pad must be connected to a solid ground plane
(26)	DCC	Power	DC/DC converter output pin
(27)	DEC4	Power	1V3 regulator supply decoupling. Input from DC/DC converter.
(28)	P0.31	Digital I/O	General-purpose digital I/O
	AIN7	Analog input	SAADC/COMP/LPCOMP input
(29)	P0.27	Digital I/O	General-purpose digital I/O
(30)	P0.25	Digital I/O	General-purpose digital I/O
(31)	P0.30	Digital I/O	General-purpose digital I/O
	AIN6	Analog input	SAADC/COMP/LPCOMP input
(32)	P0.29	Digital I/O	General-purpose digital I/O
	AIN5	Analog input	SAADC/COMP/LPCOMP input
(33)	P0.28	Digital I/O	General-purpose digital I/O
	AIN4	Analog input	SAADC/COMP/LPCOMP input
(34)	P0.11	Digital I/O	General-purpose digital I/O
(35)	P0.26	Digital I/O	General-purpose digital I/O
(36)	P0.19	Digital I/O	General-purpose digital I/O
(37)	GND	Ground	The pad must be connected to a solid ground plane
(38)	P0.24	Digital I/O	General-purpose digital I/O
(39)	P0.20	Digital I/O	General-purpose digital I/O
	TraceCLK		Trace port clock output
(40)	P0.16	Digital I/O	General-purpose digital I/O
	TraceData(1)		Trace port output
(41)	P0.14	Digital I/O	General-purpose digital I/O
	TraceData(3)		Trace port output

2.6. GPIO Located Near the Radio

Below remarks are extracted from Nordic's nRF52832 Spec. Any updates shall refer to Nordic's official release as final reference.

4.3.1 GPIO located near the radio

Radio performance parameters, such as sensitivity, may be affected by high frequency digital I/O with large sink/source current close to the Radio power supply and antenna pins.



Pin	GPIO	Recommended usage
F2	P0.22	Low drive, low frequency I/O only.
E2	P0.23	
E1	P0.24	
B3	P0.25	
D3	P0.26	
B4	P0.27	
A3	P0.28	
A4	P0.29	
A5	P0.30	
B5	P0.31	

3. Main Chip Solution

RF IC	Crystal Frequency
Nordic NRF52832	32MHZ

32MHz is already inside the module.

4. Shipment Packaging Information

Antenna	Model
Chip/Ceramic Antenna	MDBT42-512K
	
PCB/Printed Antenna	MDBT42-P512K
	

One yellow dot is for modules with revision 2 IC. Date code starts with 813 and later.

- Unit Weight of Module:

MDBT42-512K: 0.40g / pc (± 0.02 g) ; MDBT42-P512K: 0.38g / pc (± 0.02 g)

- Packaging Type: Tray only

- Minimum Package Quantity (MPQ): 88 pcs per Tray

- Carton Contents: 1760 pcs per carton (20 Full Tray + 1 Empty Tray)

- Dimension of Carton: (L) 37 x (W) 21 x (H) 13 cm

- Gross Weight: approx. 2.40 kgs per full carton (contains 1760pcs)



4.1. Marking on Metal Shielding

Raytac Corporation
FCC ID: SH6MDBT42
IC: 8017A-MDBT42
CMIIT ID: 2017DJ0350
Model No.: MDBT42
   ® 201-170035



5. Specification

Any technical spec shall refer to Nordic's official documents as final references.

5.1. Absolute Maximum Ratings

	Min.	Max.	Unit
Supply voltages			
VDD	-0.3	+3.9	V
VSS		0	V
I/O pin voltage			
$V_{I/O}, VDD \leq 3.6 \text{ V}$	-0.3	$VDD + 0.3 \text{ V}$	V
$V_{I/O}, VDD > 3.6 \text{ V}$	-0.3	3.9 V	V
NFC antenna pin current			
$I_{NFC1/2}$		80	mA
Radio			
RF input level		10	dBm
Flash memory			
Endurance	10 000		Write/erase cycles
Retention	10 years at 40°C		
Environmental WLCSP, 3.0×3.2 mm package			
Storage temperature	-40	+125	°C
MSL		1	
ESD HBM (human body model)		2	kV
ESD CDM (charged device model)		500	V

5.2. Operation Conditions

Symbol	Parameter	Min.	Nom.	Max.	Units
VDD	Supply voltage, independent of DCDC enable	1.7	3.0	3.6	V
t_{R_VDD}	Supply rise time (0 V to 1.7 V)			60	ms
TA	Operating temperature	-40	25	85	°C

Important: The on-chip power-on set circuitry may not function properly for rise times longer than the specified maximum.

5.3. Electrical Specifications

5.3.1. General Radio Characteristics

Symbol	Description	Min.	Typ.	Max.	Units
f_{OP}	Operating frequencies	2360		2500	MHz
$f_{PLL,PROG,RES}$	PLL programming resolution		2		kHz
$f_{PLL,CH,SP}$	PLL channel spacing		1		MHz
$f_{DELTA,1M}$	Frequency deviation @ 1 Msps		± 170		kHz
$f_{DELTA,BLE,1M}$	Frequency deviation @ BLE 1Msps		± 250		kHz
$f_{DELTA,2M}$	Frequency deviation @ 2 Msps		± 320		kHz
$f_{DELTA,BLE,2M}$	Frequency deviation @ BLE 2 Msps		± 500		kHz
$f_{sk_{SPS}}$	On-the-air data rate	1		2	Msps

5.3.2. Radio Current Consumption (Transmitter)

Symbol	Description	Min.	Typ.	Max.	Units
$I_{TX,PLUS4dBm,DCDC}$	TX only run current (DCDC, 3V) $P_{RF} = +4$ dBm		7.5		mA
$I_{TX,PLUS4dBm}$	TX only run current $P_{RF} = +4$ dBm		16.6		mA
$I_{TX,0dBm,DCDC}$	TX only run current (DCDC, 3V) $P_{RF} = 0$ dBm		5.3		mA
$I_{TX,0dBm}$	TX only run current $P_{RF} = 0$ dBm		11.6		mA
$I_{TX,MINUS4dBm,DCDC}$	TX only run current DCDC, 3V $P_{RF} = -4$ dBm		4.2		mA
$I_{TX,MINUS4dBm}$	TX only run current $P_{RF} = -4$ dBm		9.3		mA
$I_{TX,MINUS8dBm,DCDC}$	TX only run current DCDC, 3V $P_{RF} = -8$ dBm		3.8		mA
$I_{TX,MINUS8dBm}$	TX only run current $P_{RF} = -8$ dBm		8.4		mA
$I_{TX,MINUS12dBm,DCDC}$	TX only run current DCDC, 3V $P_{RF} = -12$ dBm		3.5		mA
$I_{TX,MINUS12dBm}$	TX only run current $P_{RF} = -12$ dBm		7.7		mA
$I_{TX,MINUS16dBm,DCDC}$	TX only run current DCDC, 3V $P_{RF} = -16$ dBm		3.3		mA
$I_{TX,MINUS16dBm}$	TX only run current $P_{RF} = -16$ dBm		7.3		mA
$I_{TX,MINUS20dBm,DCDC}$	TX only run current DCDC, 3V $P_{RF} = -20$ dBm		3.2		mA
$I_{TX,MINUS20dBm}$	TX only run current $P_{RF} = -20$ dBm		7.0		mA
$I_{TX,MINUS40dBm,DCDC}$	TX only run current DCDC, 3V $P_{RF} = -40$ dBm		2.7		mA
$I_{TX,MINUS40dBm}$	TX only run current $P_{RF} = -40$ dBm		5.9		mA
$I_{START,TX,DCDC}$	TX start-up current DCDC, 3V, $P_{RF} = 4$ dBm		4.0		mA
$I_{START,TX}$	TX start-up current, $P_{RF} = 4$ dBm		8.8		mA

5.3.3. Radio Current Consumption (Receiver)

Symbol	Description	Min.	Typ.	Max.	Units
I _{RX,1M,DCDC}	RX only run current (DCDC, 3V) 1Msps / 1Msps BLE		5.4		mA
I _{RX,1M}	RX only run current 1Msps / 1Msps BLE		11.7		mA
I _{RX,2M,DCDC}	RX only run current (DCDC, 3V) 2Msps / 2Msps BLE		5.8		mA
I _{RX,2M}	RX only run current 2Msps / 2Msps BLE		12.9		mA
I _{START,RX,DCDC}	RX start-up current (DCDC 3V)		3.5		mA
I _{START,RX,LDO}	RX start-up current (LDO 3V)		7.5		mA

5.3.4. Transmitter Specification

Symbol	Description	Min.	Typ.	Max.	Units
P _{RF}	Maximum output power		4	6	dBm
P _{RFC}	RF power control range		24		dB
P _{RFCR}	RF power accuracy			±4	dB
P _{RF1,1}	1st Adjacent Channel Transmit Power 1 MHz (1 Msps Nordic proprietary mode)		-25		dBc
P _{RF2,1}	2nd Adjacent Channel Transmit Power 2 MHz (1 Msps Nordic proprietary mode)		-50		dBc
P _{RF1,2}	1st Adjacent Channel Transmit Power 2 MHz (2 Msps Nordic proprietary mode)		-25		dBc
P _{RF2,2}	2nd Adjacent Channel Transmit Power 4 MHz (2 Msps Nordic proprietary mode)		-50		dBc
P _{RF1,2,BLE}	1st Adjacent Channel Transmit Power 2 MHz (2 Msps BLE mode)		-20		dBc
P _{RF2,2,BLE}	2nd Adjacent Channel Transmit Power 4 MHz (2 Msps BLE mode)		-50		dBc

5.3.5. Receiver Operation

Symbol	Description	Min.	Typ.	Max.	Units
P _{RX,MAX}	Maximum received signal strength at < 0.1% BER		0		dBm
P _{SENS,IT,1M}	Sensitivity, 1Msps nRF mode ¹		-93		dBm
P _{SENS,IT,SP,1M,BLE}	Sensitivity, 1Msps BLE ideal transmitter, <=37 bytes BER=1E-3 ²		-96		dBm
P _{SENS,IT,LP,1M,BLE}	Sensitivity, 1Msps BLE ideal transmitter >=128 bytes BER=1E-4 ³		-95		dBm
P _{SENS,IT,2M}	Sensitivity, 2Msps nRF mode ⁴		-89		dBm

1. Typical sensitivity applies when ADDR0 is used for receiver address correlation. When ADDR [1...7] are used for receiver address correlation, the typical sensitivity for this mode is degraded by 3dB.
2. As defined in the Bluetooth Core Specification v4.0 Volume 6: Core System Package (Low Energy Controller Volume).
3. Equivalent BER limit < 10E-04.
4. Same as remark 1.

5.3.6. RX Selectivity

Symbol	Description	Min.	Typ.	Max.	Units
C/I _{1M,co-channel}	1 Msps mode, Co-Channel interference		9		dB
C/I _{1M,-1MHz}	1 Msps mode, Adjacent (-1 MHz) interference		-2		dB
C/I _{1M,+1MHz}	1 Msps mode, Adjacent (+1 MHz) interference		-10		dB
C/I _{1M,-2MHz}	1 Msps mode, Adjacent (-2 MHz) interference		-19		dB
C/I _{1M,+2MHz}	1 Msps mode, Adjacent (+2 MHz) interference		-42		dB
C/I _{1M,-3MHz}	1 Msps mode, Adjacent (-3 MHz) interference		-38		dB
C/I _{1M,+3MHz}	1 Msps mode, Adjacent (+3 MHz) interference		-48		dB
C/I _{1M,±6MHz}	1 Msps mode, Adjacent (≥6 MHz) interference		-50		dB
C/I _{1MBLE,co-channel}	1 Msps BLE mode, Co-Channel interference		6		dB
C/I _{1MBLE,-1MHz}	1 Msps BLE mode, Adjacent (-1 MHz) interference		-2		dB
C/I _{1MBLE,+1MHz}	1 Msps BLE mode, Adjacent (+1 MHz) interference		-9		dB
C/I _{1MBLE,-2MHz}	1 Msps BLE mode, Adjacent (-2 MHz) interference		-22		dB
C/I _{1MBLE,+2MHz}	1 Msps BLE mode, Adjacent (+2 MHz) interference		-46		dB
C/I _{1MBLE,>3MHz}	1 Msps BLE mode, Adjacent (≥3 MHz) interference		-50		dB
C/I _{1MBLE,image}	Image frequency Interference		-22		dB
C/I _{1MBLE,image,1MHz}	Adjacent (1 MHz) interference to in-band image frequency		-35		dB
C/I _{1MBLE,image}	Image frequency Interference		-22		dB
C/I _{1MBLE,image,1MHz}	Adjacent (1 MHz) interference to in-band image frequency		-35		dB
C/I _{2M,co-channel}	2 Msps mode, Co-Channel interference		10		dB
C/I _{2M,-2MHz}	2 Msps mode, Adjacent (-2 MHz) interference		6		dB
C/I _{2M,+2MHz}	2 Msps mode, Adjacent (+2 MHz) interference		-14		dB
C/I _{2M,-4MHz}	2 Msps mode, Adjacent (-4 MHz) interference		-20		dB
C/I _{2M,+4MHz}	2 Msps mode, Adjacent (+4 MHz) interference		-44		dB
C/I _{2M,-6MHz}	2 Msps mode, Adjacent (-6 MHz) interference		-42		dB
C/I _{2M,+6MHz}	2 Msps mode, Adjacent (+6 MHz) interference		-47		dB
C/I _{2M,≥12MHz}	2 Msps mode, Adjacent (≥12 MHz) interference		-52		dB
C/I _{2MBLE,co-channel}	2 Msps BLE mode, Co-Channel interference		7		dB
C/I _{2MBLE,±2MHz}	2 Msps BLE mode, Adjacent (±2 MHz) interference		0		dB
C/I _{2MBLE,±4MHz}	2 Msps BLE mode, Adjacent (±4 MHz) interference		-47		dB
C/I _{2MBLE,≥6MHz}	2 Msps BLE mode, Adjacent (≥6 MHz) interference		-49		dB
C/I _{2MBLE,image}	Image frequency Interference		-21		dB
C/I _{2MBLE,image, 2MHz}	Adjacent (2 MHz) interference to in-band image frequency		-36		dB

Remark: Wanted signal level at PIN = -67 dBm. One interferer is used, having equal modulation as the wanted signal. The input power of the interferer where the sensitivity equals BER = 0.1% is presented.

5.3.7. RX Intermodulation

Symbol	Description	Min.	Typ.	Max.	Units
$P_{IMD,1M}$	IMD performance, 1 Msps (3 MHz, 4 MHz, and 5 MHz offset)		-33		dBm
$P_{IMD,1M,BLE}$	IMD performance, BLE 1 Msps (3 MHz, 4 MHz, and 5 MHz offset)		-30		dBm
$P_{IMD,2M}$	IMD performance, 2 Msps (6 MHz, 8 MHz, and 10 MHz offset)		-33		dBm
$P_{IMD,2M,BLE}$	IMD performance, BLE 2 Msps (6 MHz, 8 MHz, and 10 MHz offset)		-32		dBm

Remark: Wanted signal level at PIN = -64dBm. Two interferers with equal input power are used. The interferer closest in frequency is not modulated, the other interferer is modulated equal with the wanted signal. The input power of the interferers where the sensitivity equals BER = 0.1% is presented.

5.3.8. Radio Timing Parameters

Symbol	Description	Min.	Typ.	Max.	Units
t_{TXEN}	Time between TXEN task and READY event after channel FREQUENCY configured		140		us
$t_{TXEN,FAST}$	Time between TXEN task and READY event after channel FREQUENCY configured (Fast Mode)		40		us
$t_{TXDISABLE}$	Time between DISABLE task and DISABLED event when the radio was in TX and mode is set to 1Msps		6		us
$t_{TXDISABLE,2M}$	Time between DISABLE task and DISABLED event when the radio was in TX and mode is set to 2Msps		4		us
t_{RXEN}	Time between the RXEN task and READY event after channel FREQUENCY configured in default mode		140		us
$t_{RXEN,FAST}$	Time between the RXEN task and READY event after channel FREQUENCY configured in fast mode		40		us
t_{SWITCH}	The minimum time taken to switch from RX to TX or TX to RX (channel FREQUENCY unchanged)		20		us
$t_{RXDISABLE}$	Time between DISABLE task and DISABLED event when the radio was in RX		0		us
$t_{TXCHAIN}$	TX chain delay		0.6		us
$t_{RXCHAIN}$	RX chain delay		9.4		us
$t_{RXCHAIN,2M}$	RX chain delay in 2Msps mode		5		us

5.3.9. RSSI Specifications

Symbol	Description	Min.	Typ.	Max.	Units
$RSSI_{ACC}$	RSSI Accuracy Valid range -90 to -20 dBm		±2		dB
$RSSI_{RESOLUTION}$	RSSI resolution		1		dB
$RSSI_{PERIOD}$	Sample period		0.25		us

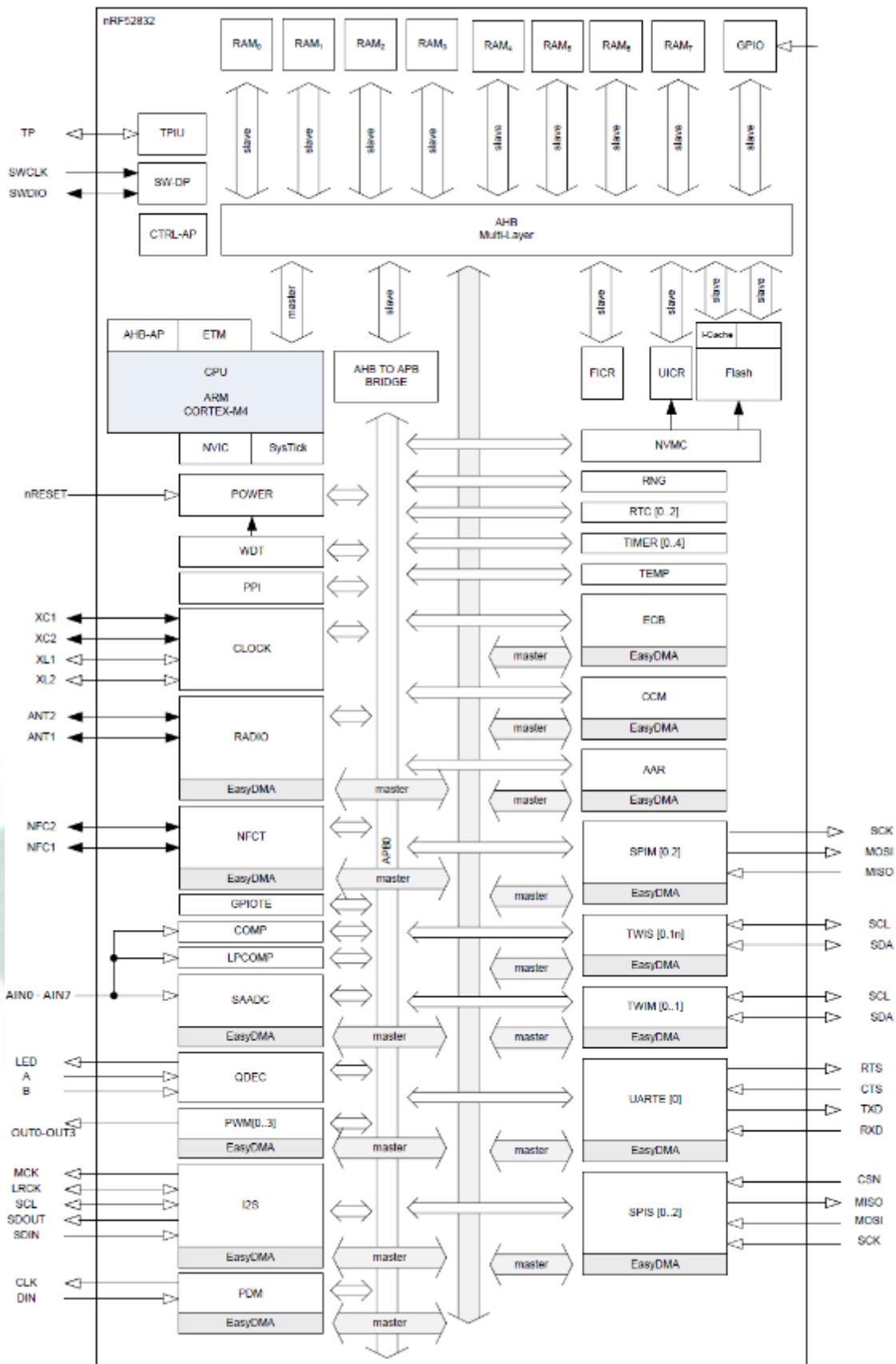
5.3.10. CPU

Symbol	Description	Min.	Typ.	Max.	Units
W_{FLASH}	CPU wait states, running from flash, cache disabled	0		2	
$W_{FLASHCACHE}$	CPU wait states, running from flash, cache enabled	0		3	
W_{RAM}	CPU wait states, running from RAM			0	
$I_{DDFLASHCACHE}$	CPU current, running from flash, cache enabled, LDO		7.4		mA
$I_{DDFLASHCACHEDCDC}$	CPU current, running from flash, cache enabled, DCDC 3V		3.7		mA
$I_{DDFLASH}$	CPU current, running from flash, cache disabled, LDO		8.0		mA
$I_{DDFLASHDCDC}$	CPU current, running from flash, cache disabled, DCDC 3V		3.9		mA
I_{DDRAM}	CPU current, running from RAM, LDO		6.7		mA
$I_{DDRAMDCDC}$	CPU current, running from RAM, DCDC 3V		3.3		mA
$I_{DDFLASH/MHz}$	CPU efficiency, running from flash, cache enabled, LDO		125		$\mu A/$ MHz
$I_{DDFLASHDCDC/MHz}$	CPU efficiency, running from flash, cache enabled, DCDC 3V		58		$\mu A/$ MHz
CM_{FLASH}	CoreMark ⁵ , running from flash, cache enabled		215		CoreM
$CM_{FLASH/MHz}$	CoreMark per MHz, running from flash, cache enabled		3.36		CoreM MHz
$CM_{FLASH/mA}$	CoreMark per mA, running from flash, cache enabled, DCDC 3V		58		CoreM mA

5.3.11. Power Management

Symbol	Description	Min.	Typ.	Max.	Units
$I_{ON_RAMOFF_EVENT}$	System ON, No RAM retention, Wake on any event		1.2		μA
$I_{ON_RAMON_EVENT}$	System ON, Full RAM retention, Wake on any event		1.5		μA
$I_{ON_RAMOFF_RTC}$	System ON, No RAM retention, Wake on RTC		1.9		μA
$I_{OFF_RAMOFF_RESET}$	System OFF, No RAM retention, Wake on reset		0.3		μA
$I_{OFF_RAMOFF_GPIO}$	System OFF, No RAM retention, Wake on GPIO		0.3		μA
$I_{OFF_RAMOFF_LPCOMP}$	System OFF, No RAM retention, Wake on LPCOMP		1.9		μA
$I_{OFF_RAMOFF_NFC}$	System OFF, No RAM retention, Wake on NFC field		0.7		μA
$I_{OFF_RAMON_RESET}$	System OFF, Full 64 kB RAM retention, Wake on reset		0.7		μA

6. Block Diagram



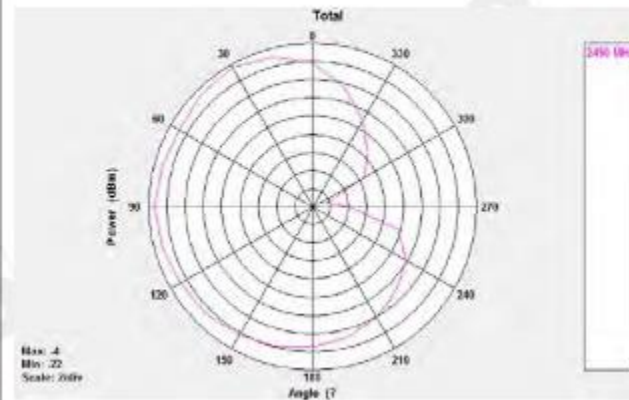
7. Antenna

7.1. MDBT42

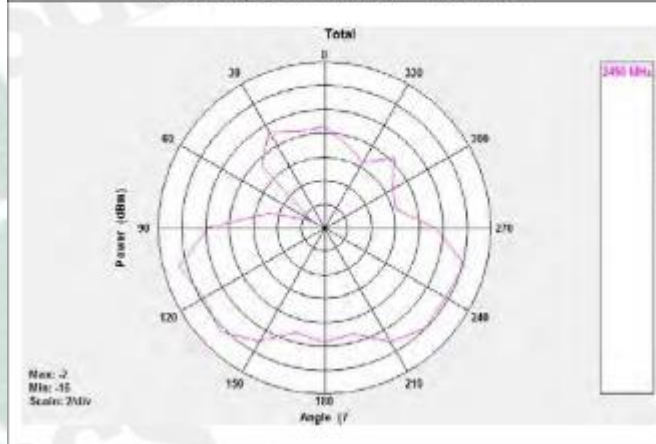
Test Result

Frequency (MHz)	2400	2410	2420	2430	2440	2450	2460	2470	2480	2490	2500
Gain (dBi)	-3.68	-2.91	-2.34	-1.98	-1.66	-1.60	-1.77	-2.09	-2.60	-3.35	-4.10
Peak EIRP (dBm)	-3.68	-2.91	-2.34	-1.98	-1.66	-1.60	-1.77	-2.09	-2.60	-3.35	-4.10
Directivity (dBi)	4.98	5.11	5.12	5.02	4.93	4.76	4.58	4.38	4.11	3.77	3.42

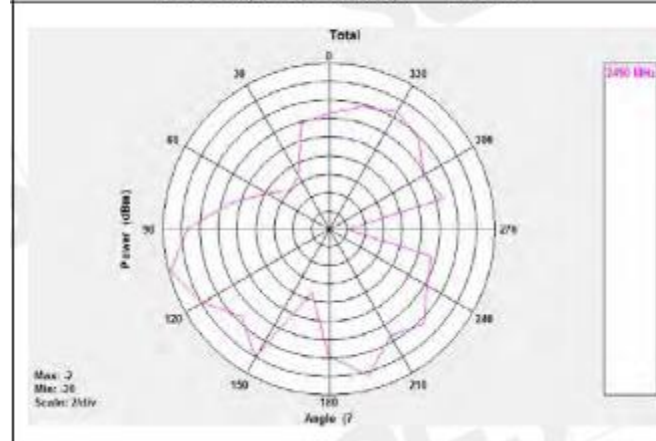
**Free Space
EIRP (2450 MHz) – XY cut**



**Free Space
EIRP (2450 MHz) – XZ cut**



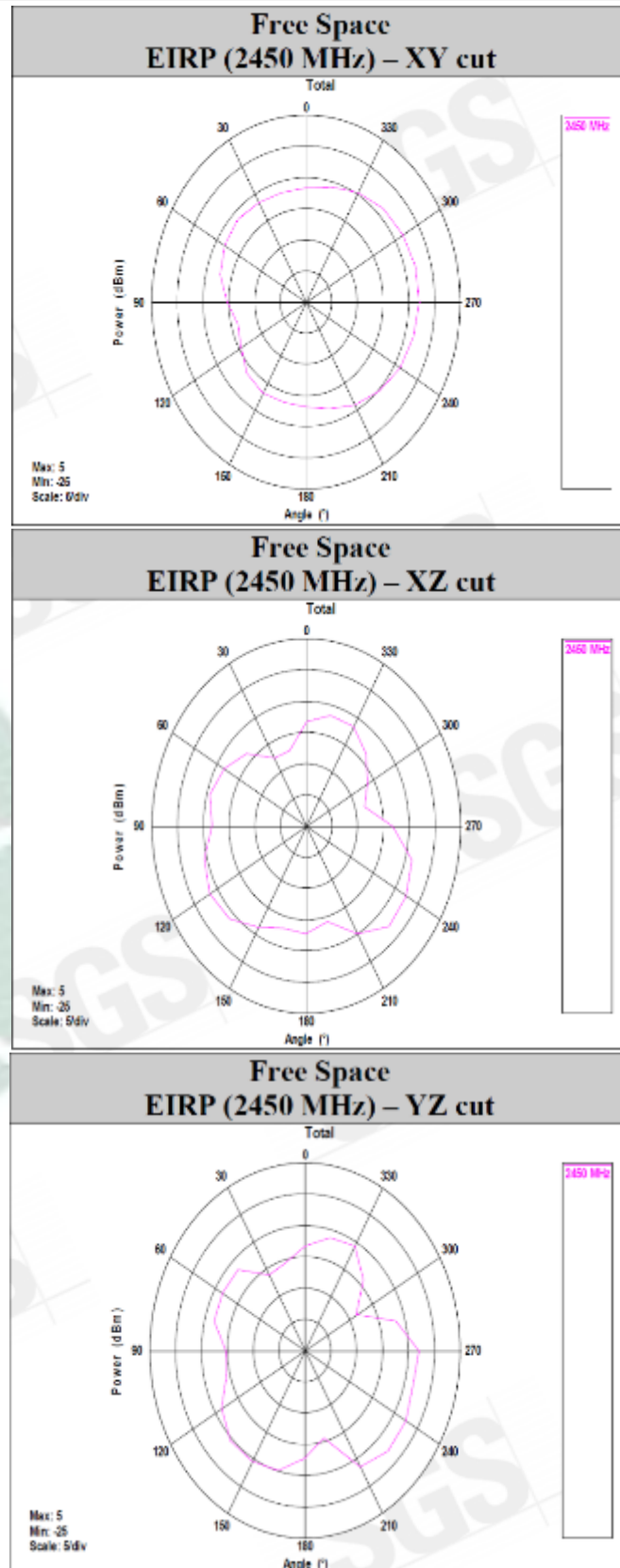
**Free Space
EIRP (2450 MHz) – YZ cut**



7.2. MDBT42-P

Test Result

Frequency (MHz)	2400	2410	2420	2430	2440	2450	2460	2470	2480	2490	2500
Gain (dBi)	-3.87	-3.06	-2.31	-2.01	-2.04	-2.31	-2.24	-1.96	-1.61	-1.71	-1.97
Peak EIRP (dBm)	-3.87	-3.06	-2.31	-2.01	-2.04	-2.31	-2.24	-1.96	-1.61	-1.71	-1.97
Directivity (dBi)	3.79	4.00	4.25	4.17	3.86	3.51	3.54	3.91	4.39	4.44	4.49



8. Reference Circuit

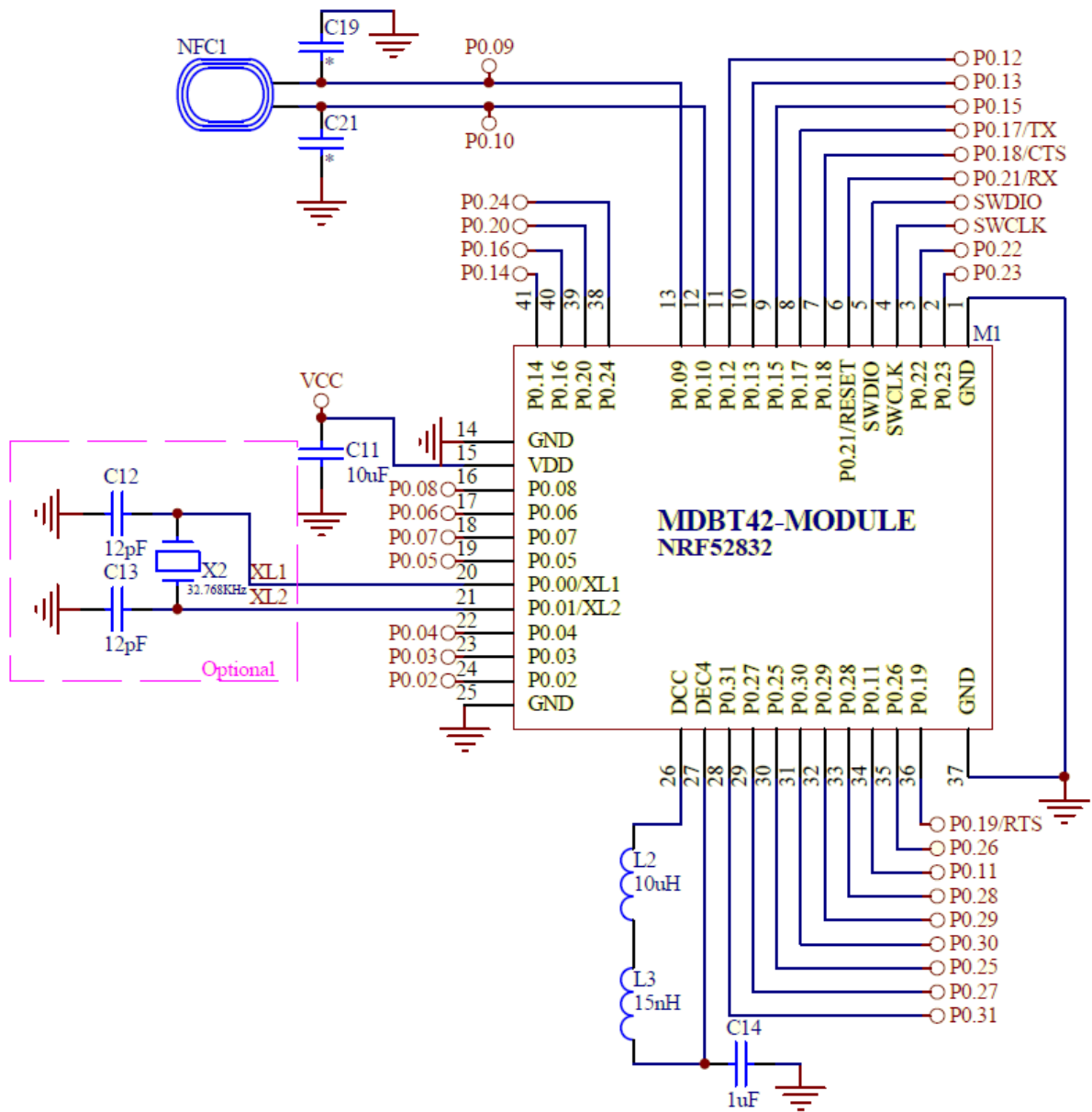
Module's default is using "DC-DC mode", and must connect it to external 32.768khz to work.

REMARK:

**** When NOT using DC-DC mode, please remove L2 / L3 / C14. ****

**** When NOT using NFC, please remove NFC1 / C19 / C21. ****

**** When using internal 32.768khz RC oscillator, please remove X2 / C12 / C13. ****



9. Certification

9.1. Declaration ID

QDL Bluetooth® qualified design listing

The Bluetooth SIG Hereby Recognizes

Raytac Corporation
Member Company

MDBT42 Series nRF52 Bluetooth Low Energy Module
Qualified Design Name

Declaration ID: D033661
Qualified Design ID: 91882
Specification Name: 4.2
Project Type: End Product
Model Number: MDBT42/MDBT42-P/MDBT42Q/MDBT42Q-P/MDBT42V/MDBT42V-P
Listing Date: 29 December 2016 Assessment Date: 29 December 2016
Hardware Version Number: V1 Software Version Number:

This certificate acknowledges the Bluetooth® Specifications declared by the member are achieved in accordance with the Bluetooth Qualification Process as specified within the Bluetooth Specifications and as required within the current PRD

 **Bluetooth®**

QDL Bluetooth® qualified design listing

The Bluetooth SIG Hereby Recognizes

Raytac Corporation
Member Company

Multiprofile Subsystem for MDBTXX series module
Qualified Design Name

Declaration ID: D033622
Qualified Design ID: 91659
Specification Name: 4.2
Project Type: Profile Subsystem
Model Number: Multiprofile Subsystem for MDBTXX series module
Listing Date: 19 December 2016 Assessment Date: 19 December 2016
Hardware Version Number: NA Software Version Number: 1

This certificate acknowledges the Bluetooth® Specifications declared by the member are achieved in accordance with the Bluetooth Qualification Process as specified within the Bluetooth Specifications and as required within the current PRD

 **Bluetooth®**

QDL Bluetooth® qualified design listing

The Bluetooth SIG Hereby Recognizes

Raytac Corporation

Member Company

nRF52xxx Bluetooth Module

Qualified Design Name

Declaration ID: D036781

Qualified Design ID: 100551

Specification Name: 5.0

Project Type: End Product

Model Number: MDBT42/MDBT42-P/MDBT42Q/MDBT42Q-P/MDBT42V/MDBT42V-P

Listing Date: 30 August 2017

Assessment Date: 30 August 2017

Hardware Version Number: 1

Software Version Number: 2

This certificate acknowledges the *Bluetooth*® Specifications declared by the member are achieved in accordance with the Bluetooth Qualification Process as specified within the Bluetooth Specifications and as required within the current PRD



9.2. FCC Certificate (USA)



TCB

**GRANT OF EQUIPMENT
AUTHORIZATION**

Certification
Issued Under the Authority of the
Federal Communications Commission

By:

Telefication B.V.
Edisonstraat 12a
Zevenaar, NL-6902 PK
Netherlands

TCB

Raytac Corp.
5F., No.3, Jiankang Rd., Zhonghe Dist.,
New Taipei City,, 23586
Taiwan

Attention: Venson Liao , R&D Manager

Date of Grant: 02/13/2017

Application
Dated: 02/10/2017

NOT TRANSFERABLE

EQUIPMENT AUTHORIZATION is hereby issued to the named
GRANTEE, and is VALID ONLY for the equipment identified hereon for
use under the Commission's Rules and Regulations listed below.

FCC IDENTIFIER:	SH6MDBT42		
Name of Grantee:	Raytac Corp.		
Equipment Class:	Digital Transmission System		
Notes:	BT 4.2 Module		
Modular Type:	Single Modular		

Grant Notes	FCC Rule Parts	Frequency Range (MHZ)	Output Watts	Frequency Emission Tolerance Designator
	15C	2402.0 - 2480.0	0.0027	

Output power listed is conducted. This is a portable device. This grant is valid only when the module is sold to OEM integrators and must be installed by the OEM or OEM integrators. The antennas used for this transmitter must not be co-located or operating in conjunction with any other antenna or transmitter. End-users may not be provided with the module installation instructions. OEM integrators and end-users must be provided with transmitter operating conditions for satisfying RF exposure compliance.

Certificate No.:
172180316/AA/00

Gürhan Vural
Product Assessor


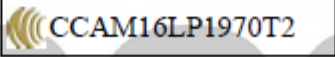


9.3. TELEC Certificate (Japan)

<p>telefication bv The Netherlands Chamber of Commerce 51565536 www.telefication.com</p>	
<p>Certificate of Radio Equipment in JAPAN No: 201-170035 / 00</p>	
<p>Telefication, operating as Conformity Assessment Body (CAB ID Number: 201) with respect to Japan, declares that the listed product complies with the Technical Regulations Conformity Certification of Terminal equipment (ordinance of MPT N° 31,1984)</p>	
<p>Product description: BT 4.2 Module Trademark: Raytac Type designation: MDBT42 Hardware / Software version: 1 / 1 Variants: See Annex 3</p>	
<p>Manufacturer: Raytac Corporation Address: 5F, No. 3, Jiankang Rd., Zhonghe Dist. City: 23586 New Taipei City Country: Taiwan</p>	
<p>This statement is granted to:</p>	
<p>Name: Raytac Corporation Address: 5F, No. 3, Jiankang Rd., Zhonghe Dist. City: 23586 New Taipei City Country: Taiwan</p>	
<p>This statement has THREE Annexes.</p>	
<p>Zevenaar, 24 January 2017</p>	
<p>CAB</p>	
<p>Ramy Nabod Product Assessor</p>	
	

9.4. NCC Certificate (Taiwan)

MDBT42

	台灣檢驗科技股份有限公司
低功率射頻電機型式認證證明	
一、申請者：	勁達國際電子有限公司
地 址：	新北市中和區建康路3號5樓
二、製造廠商：	Ginstar Corporation
三、器材名稱：	BT 4.2 Module
四、廠 牌：	Raytac
五、型 號：	MDBT42
六、發射功率：	BT V4.2 single mode LE (GFSK): 4.30dBm (Peak)
七、工作頻率：	2402-2480MHz
八、審驗日期：	105年12月29日
九、審驗合格標籤式樣：	
說明：	
1. 請依上列標籤式樣自製標籤，標貼或印鑄於器材本體明顯處，始得販賣或公開陳列。	
2. 經型式認證合格之低功率射頻電機，其廠牌、型號、設計、射頻性能如有變更，應重新申請型式認證。	
3. 違反低功率電波輻射性電機管理辦法之規定，擅自使用或變更無線電頻率、電功率者，除依電信法規定處罰外，驗證機關(構)並得廢止其型式認證證明或型式認證標籤。	
4. 送審廠商應保留送審樣品供日後核對。	
5. 本型式認證證明及其合格標籤使用權專屬取得本證明者。依電信管制射頻器材審驗辦法第15條規定，持有人得經由網際網路申請同意他人於同廠牌同型號之電信管制射頻器材使用型式認證標籤，並於次日起30天內，應檢具「電信管制射頻器材審驗合格標籤，或符合性聲明標籤同意使用備查表」送國家通訊傳播委員會備查。	
備註：	
1. 本器材符合低功率射頻電機技術規範(3.10.1)之規定。	
2. 本公司僅對無線射頻特性技術規範辦理型式認證，其他仍須依本國相關法規辦理。	
3. 本器材使用天線型態: Chip Antenna，天線廠牌: Raytac，型號: MDBT42，增益: -2.28dBi。	
4. 本案審驗模組為完全模組，適用於任何平台。【平台】定義如下:若器材部組裝本案審驗模組，消費者仍能正常使用該器材主要功能，該器材得視為平台。若器材不組裝本案審驗模組，消費者不能正常使用該器材主要功能，該器材不能視為平台，該類不同廠牌型號器材組裝本案審驗模組後，須分別申請型式認證。	
5. 本公司係經國家通訊傳播委員會委託之驗證機構，核發本型式認證證明。	

台灣檢驗
科技股份
有限公司
電信設備
審驗印章

MDBT42-P

SGS

台灣檢驗科技股份有限公司

低功率射頻電機型式認證證明

- 一、申請者：勁達國際電子有限公司
地址：新北市中和區建康路3號5樓
- 二、製造廠商：Ginstar Corporation
- 三、器材名稱：BT 4.2 Module
- 四、廠牌：Raytac
- 五、型號：MDBT42-P
- 六、發射功率：BT V4.2 single mode LE (GFSK): 4.30dBm (Peak)
- 七、工作頻率：2402-2480MHz
- 八、審驗日期：105年12月29日
- 九、審驗合格標籤式樣：



說明：

- 請依上列標籤式樣自製標籤，標貼或印鑄於器材本體明顯處，始得販賣或公開陳列。
- 經型式認證合格之低功率射頻電機，其廠牌、型號、設計、射頻性能如有變更，應重新申請型式認證。
- 違反低功率電波輻射性電機管理辦法之規定，擅自使用或變更無線電頻率、電功率者，除依電信法規定處罰外，驗證機關(構)並得廢止其型式認證證明或型式認證標籤。
- 送審廠商應保留送審樣品供日後核對。
- 本型式認證證明及其合格標籤使用權專屬取得本證明者。依電信管制射頻器材審驗辦法第15條規定，持有人得經由網際網路申請同意他人於同廠牌同型號之電信管制射頻器材使用型式認證標籤，並於次日起30天內，應檢具「電信管制射頻器材審驗合格標籤，或符合性聲明標籤同意使用備查表」送國家通訊傳播委員會備查。

備註：

- 本器材符合低功率射頻電機技術規範(3.10.1)之規定。
- 本公司僅對無線射頻特性技術規範辦理型式認證，其他仍須依本國相關法規辦理。
- 本器材使用天線型態: PCB Antenna，天線廠牌: Raytac，型號: MDBT42-P，增益: -2.98dBi。
- 本案審驗模組為完全模組，適用於任何平台。【平台】定義如下:若器材部組裝本案審驗模組，消費者仍能正常使用該器材主要功能，該器材得視為平台。若器材不組裝本案審驗模組，消費者不能正常使用該器材主要功能，該器材不能視為平台，該類不同廠牌型號器材組裝本案審驗模組後，須分別申請型式認證。
- 本公司係經國家通訊傳播委員會委託之驗證機構，核發本型式認證證明。

9.5. CE Test Report (EU)

SGS

SGS Reference No: E1/2017/30010C

VERIFICATION OF EMC COMPLIANCE

Verification No.	: E1/2017/30010C
Representative Model No.	: MDBT42
Added Model(s)	: MDBT42-P
Product Name	: BT4.2 Module
Brand Name	: Raytac
Applicant	: Raytac Corporation
Address of Applicant	: 5F, No.3, Jiankang Rd., Zhonghe Dist., New Taipei City , 23586, Taiwan
Test Report Number	: E1/2017/30010
Date of Issue	: Mar. 20, 2017
Applicable Standards	: EN 301 489-1v2.1.1: 2017, EN 301 489-17v3.1.1: 2017 EN 55032 : 2015 EN 61000-4-2 : 2009, EN 61000-4-3 : 2006+A1:2008+A2:2010

Conclusion
The apparatus meets the requirements of the above standards and hence compliance the essential requirements under article 3.1b of the RED (2014/53/EC) Directive.

*This verification is only valid for the equipment and configuration described, and in conjunction with the test report as detailed above.

CE

Authorized Signatory:
Wisely Huang

SGS TAIWAN LTD.
Wisely Huang
Technical Asst. Supervisor

9.6. IC Certificate (Canada)

<p>telefication bv The Netherlands Chamber of Commerce 51565536 www.telefication.com</p>		<p>telefication</p>						
<p>TECHNICAL ACCEPTANCE CERTIFICATE</p>		<p>CERTIFICAT D'ACCEPTABILITÉ TECHNIQUE</p>						
<p>CERTIFICATION No. No. DE CERTIFICATION</p>	<p>8017A-MDBT42</p>							
<p>TELEFICATION No. No. DE TELEFICATION</p>	<p>172170150/AA/00</p>							
<p>TEST SITE No. No. DE LABORATOIRE</p>	<p>4620A-5</p>							
<p>ISSUED TO DÉLIVRÉ A</p>	<p>Raytac Corporation</p>							
<p>TYPE OF EQUIPMENT GENRE DE MATÉRIEL</p>	<p>Bluetooth device</p>							
<p>TRADE NAME AND MODEL MARQUE ET MODELE</p>	<p>Raytac / MDBT42 Raytac / MDBT42-P</p>							
<p>CERTIFIED TO CERTIFIÉ SELON LE</p>	<p>SPECIFICATION CAHIER DES CHARGES</p>	<table border="0"> <tr> <td>RSS-102</td> <td>ISSUE</td> <td>5</td> </tr> <tr> <td>RSS-247</td> <td>EDITION</td> <td>1</td> </tr> </table>	RSS-102	ISSUE	5	RSS-247	EDITION	1
RSS-102	ISSUE	5						
RSS-247	EDITION	1						
<p>Certification of equipment means only that the equipment has met the requirements of the above-noted specification. Licence applications, where applicable to use certified equipment, are acted on accordingly by the Industry Canada issuing office and will depend on the existing radio environment, service and location of operation. This certificate is issued on condition that the holder complies and will continue to comply with the requirements and procedures issued by Industry Canada. The equipment for which this certificate is issued shall not be manufactured, imported, distributed, leased, offered for sale or sold unless the equipment complies with the applicable technical specifications and procedures issued by Industry Canada.</p>	<p>La certification du matériel signifie seulement que le matériel a satisfait aux exigences de la norme indiquée ci-dessus. Les demandes de licences nécessaires pour l'utilisation du matériel certifié sont traitées en conséquence par le bureau de délivrance d'Industrie Canada et dépendent des conditions radio ambiantes, du service et de l'emplacement d'exploitation. Le présent certificat est délivré à la condition que le titulaire satisfasse et continue de satisfaire aux exigences et aux procédures d'Industrie Canada. Le matériel à l'égard duquel le présent certificat est délivré ne doit pas être fabriqué, importé, distribué, loué, mis en vente ou vendu à moins d'être conforme aux procédures et aux spécifications techniques applicables publiées par Industrie Canada.</p>							
<p>ISSUED BY TELEFICATION BV, RECOGNIZED CERTIFICATION BODY BY INDUSTRY CANADA DÉLIVRÉ PAR TELEFICATION BV, ORGANISME DE CERTIFICATION RECONNU PAR INDUSTRIE CANADA</p>								
<p><i>I hereby attest that the subject equipment was tested and found in compliance with the above-noted specification. J'atteste, par la présente, que le matériel a fait l'objet d'essai et a été jugé conforme à la spécification ci-dessus</i></p>								
<p>DATE 16 Feb 2017 BY</p>	<p>Gürhan Vural Product Assessor</p>							
<p>This certificate has one annex.</p>								

9.7. SRRC Certificate (China)

无线电发射设备
Radio Transmission Equipment
型号核准证
Type Approval Certificate

Raytac Corporation (台湾):
根据《中华人民共和国无线电管理条例》, 经审查, 下列无线电发射设备
In accordance with the provisions on the Radio
Regulations of the People's Republic of China, the following
符合中华人民共和国无线电管理规定和
radio transmission equipment, after examination, conforms
技术标准, 其核准代码为: CMIIT ID: 2017DJ0350
to the provisions with its CMIIT ID:

有效期: 五年
Validity 五年


Sealed by issuing authority

2017年1 月13 日
Year Month Date

9.8. KC Certificate (South Korea)

CE3D-1220-54A2-ECDB

방송통신기자재등의 적합인증서 <i>Certificate of Broadcasting and Communication Equipments</i>	
상호 또는 성명 <i>Trade Name or Applicant</i>	Raytac Corporation
기자재 명칭 <i>Equipment Name</i>	특정소출력 무선기기(무선데이터통신시스템용 무선기기)
기본모델명 <i>Basic Model Number</i>	MDBT42
파생모델명 <i>Series Model Number</i>	MDBT42-P
인증번호 <i>Certification No.</i>	MSIP-CRM-ryt-MDBT42
제조사/제조국가 <i>Manufacturer/ Country of Origin</i>	Raytac Corporation / 대만
인증연월일 <i>Date of Certification</i>	2016-12-19
기타 <i>Others</i>	<p>위 기자재는 「전파법」 제58조의2 제2항에 따라 인증되었음을 증명합니다.</p> <p>It is verified that foregoing equipment has been certificated under the Clause 2, Article 58-2 of Radio Waves Act.</p> <p style="text-align: right;">2016년(Year) 12월(Month) 19일(Date)</p> <p style="text-align: center;">국립전파연구원장 </p> <p style="text-align: center;"><i>Director General of National Radio Research Agency</i></p> <p>※ 인증 받은 방송통신기자재는 반드시 「적합성평가표시」 를 부착하여 유통하여야 합니다. 위반시 과태료 처분 및 인증이 취소될 수 있습니다.</p>

9.9. RoHS & REACH Report

Please click link below to download full report.

- [RoHS Report for MDBT42 & MDBT42-P](#)
- [REACH Report for MDBT42 & MDBT42-P](#)



9.10. End-Product Label

It is suggested using following content adding to package or user manual or label to obey the regulation. Any rules of end-product label shall refer to each certification for final reference.

9.10.1. FCC (USA)

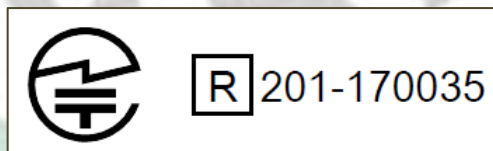
The FCC statement should be included in the user manual when there is no enough space on label. Otherwise, it should be included on the label.

“This device complies with part 15 of the FCC rules. Operation is subject to the following two conditions. (1) This device may not cause harmful interference. (2) This device must accept any interference received, including interference that may cause undesired operation.”

The final end product must be labeled in a visible area with the following: “Contain FCC ID: SH6MDBT42”.

9.10.2. TELEC (Japan)

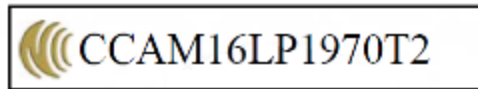
When manufacturer is placing the product on the Japanese market, the product must be affixed with the following Specified Radio Equipment marking:



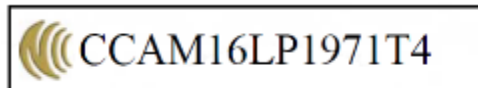
9.10.3. NCC (Taiwan)

請依下列標籤式樣自製標籤，標貼或印鑄於器材本體明顯處，始得販賣或公開陳列。

MDBT42 Series



MDBT42-P Series



平台廠商必須於平台上標示字樣「本產品內含射頻模組：ID 編號 CCAM16LP1970T2」或「本產品內含射頻模組：ID 編號 CCAM16LP1971T4」。

「平台」定義如下：若器材組裝本案模組，消費者仍能正常使用該器材主要功能，該器材得視為平台。若器材不組裝本案模組，消費者不能正常使用該器材主要功能，該器材不能視為平台。該類不同廠牌型號器材組裝本案審驗模組後，須分別申請型式認證。

9.10.4. IC (Canada)

The IC statement should be included in the user manual when there is no enough space on label. Otherwise, it should be included on the label.

“This device complies with Industry Canada license-exempt RSS Standard(s). Operation is subject to the following two conditions. (1) This device may not cause harmful interference. (2) This device must accept any interference received, including interference that may cause undesired operation.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.”

The final end product must be labeled in a visible area with the following: “Contain IC ID: 8017A-MDBT42”.

10. Notes and Cautions

Module is not designed to be used and lasting a lifetime. Like general products, it is expected to be worn out after continuous usage through the years. To assure that product will perform better and last longer, please

- Follow the guidelines of this document while designing circuit/end-product. Any discrepancy of core Bluetooth technology and technical specification of IC should refer to definition of Bluetooth Organization and Nordic Semiconductor as final reference.
- Do not supply voltage that is not within range of specification.
- Eliminate static electricity at any methods when working with the module as it may cause damage. It is highly recommended adding anti-ESD components to circuit design to prevent damage from real-life ESD events. Anti-ESD methods can be also applied in mechanical design.
- Do not expose modules under direct sunlight for long duration. Modules should be kept away from humid and salty air conditions, and any corrosive gasses or substances. Store it within -40°C to $+125^{\circ}\text{C}$ before and after installation.
- Avoid any physical shock, intense stress to the module or its surface.

The module is not suitable for life support device or system and not allowed to be used in destructive device or system in any direct, or indirect ways. The customer is agreeing to indemnify Raytac for any losses when applying modules under such application as described above.

11. Basic Facts for nRF52 Chip

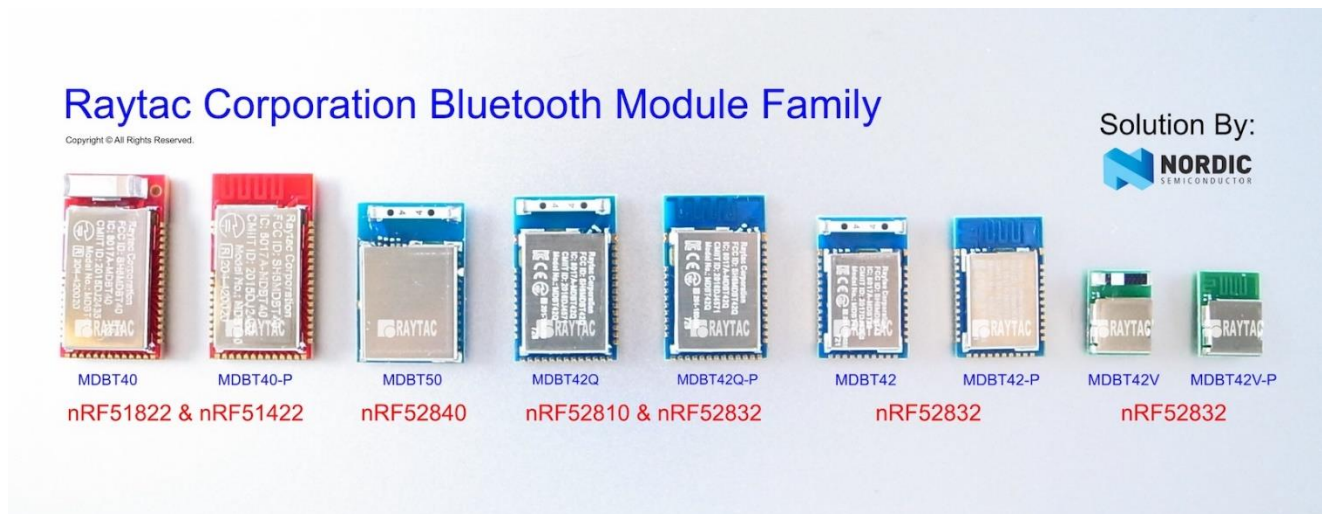
Below is the comparison chart between nRF52840, nRF52832 and nRF52810. Any discrepancy shall refer to Nordic's technical document as final reference.

	nRF52840	nRF52832	nRF52810
RAYTAC Model No.:	Click to see "Full List of Raytac's BLE Modules"		
Bluetooth 5 Long Range (x4)	V		
Bluetooth 5 High Speed	V	V	V
Bluetooth 5 Advertisement Extension (x8)	V	V	V
Flash (kBytes)	1024	512	192
RAM (kBytes)	256	64	24
ANT	V	V	V
IEEE 802.15.4	V		
ARM® TrustZone® Cryptocell	V		
USB	V		
QSPI	V		
NFC	V	V	
I2S	V	V	
SPI, TWI, UART, PWM	V	V	V
PDM	V	V	V
ADC, Comparators	V	V	V
Supply Range (V)	1.7 to 5.5	1.7 to 3.6	1.7 to 3.6

12. Useful Links

- **Nordic Infocenter:** <https://infocenter.nordicsemi.com/index.jsp>
All the necessary technical files and software development kits of Nordic's chip are on this website.
- **Nordic Developer Zone:** <https://devzone.nordicsemi.com/questions/>
A highly recommended website for firmware developer. Interact with other developers and Nordic's employees will help with your questions. The site also includes tutorials in detail to help you get started.
- **Official Page of nRF52832 :**
<https://www.nordicsemi.com/eng/Products/Bluetooth-low-energy/nRF52832>
A brief introduction to nRF52832 and download links for Nordic's developing software and SoftDevices.

Full List of Raytac's BLE Modules



MDBT40 Series

Series	Nordic Solution	Raytac No.	IC Version	Antenna	RAM	Flash Memory
MDBT40	nRF51822	MDBT40-256V3	3	Chip Antenna	16 kb	256 K
		MDBT40-256RV3			32 kb	256 K
MDBT40-P	nRF51822	MDBT40-P256V3	3	PCB Antenna	16 kb	256 K
		MDBT40-P256RV3			32 kb	256 K
MDBT40 - ANT	nRF51422	MDBT40-ANT-256V3	3	Chip Antenna	16 kb	256 K
		MDBT40-ANT-256RV3			32 kb	
MDBT40 - ANT-P	nRF51422	MDBT40-ANT-P256V3	3	PCB Antenna	16 kb	256 K
		MDBT40-ANT-P256RV3			32 kb	
MDBT40 Nano	nRF51822	MDBT40-n256V3	3	N/A	16 kb	256 K
MDBT40 - ANT-Nano	nRF51422	MDBT40-ANT-n256V3	3	N/A	16 kb	256 K

MDBT42Q Series (QFN Package IC)

Series	Nordic Solution	Raytac No.	IC Version	Antenna	RAM	Flash Memory
MDBT42Q	nRF52832	MDBT42Q-512KV2	2	Chip Antenna	64 kb	512 K
	nRF52810	MDBT42Q-192K	1		24 kb	192 K

MDBT42Q-P	nRF52832	MDBT42Q-P512KV2	2	PCB Antenna	64 kb	512 K
	nRF52810	MDBT42Q-P192K	1		24 kb	192 K

MDBT42 Series (WLCSP Package IC)

Series	Nordic Solution	Raytac No.	IC Version	Antenna	RAM	Flash Memory
MDBT42	nRF52832	MDBT42-512KV2	2	Chip Antenna	64 kb	512 K
MDBT42-P		MDBT42-P512KV2		PCB Antenna		

Series	Nordic Solution	Raytac No.	IC Version	Antenna	RAM	Flash Memory
MDBT42V	nRF52832	MDBT42V-512KV2	2	Chip Antenna	64 kb	512 K
MDBT42V-P		MDBT42V-P512KV2		PCB Antenna		

MDBT50Q Series (aQFN Package IC)

Series	Nordic Solution	Raytac No.	IC Version	Antenna	RAM	Flash Memory
MDBT50Q	nRF52840	MDBT50Q-1M	1	Chip Antenna	256 kb	1MB
MDBT50Q-P		MDBT50Q-P1M		PCB Antenna		
MDBT50Q-U		MDBT50Q-U1M		u.FL Connector		

Release Note

- 2016/11/25 Version A: 1st release
- 2017/06/12 Version B:
 - (1) Added info of granted certificates to Chapter 9.
 - (2) Updated Chapter 2, Chapter 4 and list of model no.
- 2017/10/06 Version C:
 - (1) Updated Chapter 1, Chapter 2.3 (RF layout recommendation), Chapter 4, Chapter 9 and list of model no.
 - (2) Added Chapter 10: Basic Facts for nRF52 Chips.
- 2018/04/13 Version D:
 - (1) Updated model no. to MDBT42-512KV2 and MDBT42-P512KV2 for V2 IC and updated info in Chapter 4 and list of model no.
 - (2) Corrected typo in Chapter 8.
 - (3) Added Chapter 10: Notes and Cautions and Chapter 12: Useful Links.
- 2018/05/11 Version E:
 - (1) Updated RoHS & REACH report.